

GH5CD05B3D

Hologram Laser for Automotive CD Drive

Features

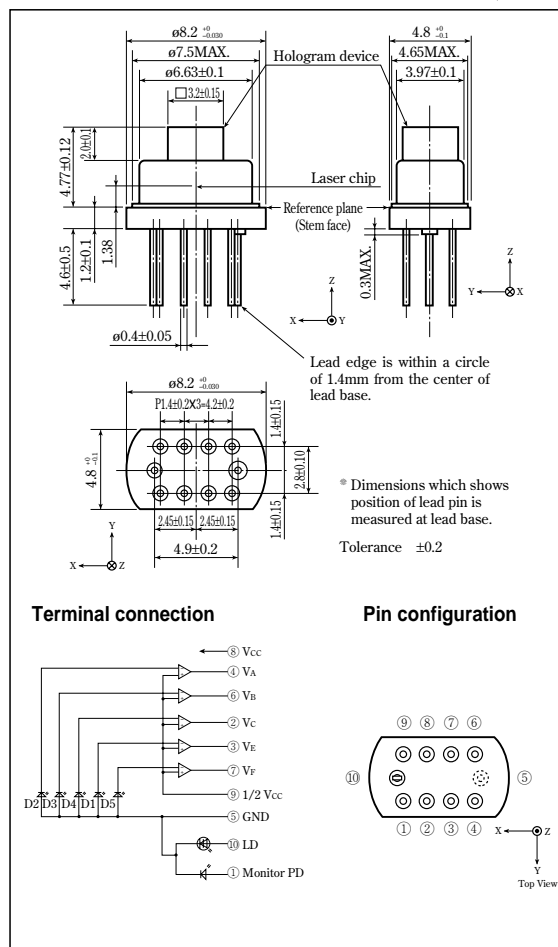
- (1) Wide operating temperature for use in automotive equipment
 - (2) 3V operation (3 to 5), it is connectable with a chip set of 3V operation
 - (3) For ×8 speed CD drives, with built-in OPIC[®] (response speed : MIN. 12MHz)
(Both for CD car navigation systems and CD players)
 - (4) Thin (4.8mm thickness) and compact package enables thin and compact pick-up design.
 - (5) With built-in beam splitter and diffraction grating
- [®]OPIC : (Optical IC) is a trademark of SHARP Corporation.
An OPIC consists of a light-detecting element and a signal-processing circuit integrated onto a single chip.

Applications

- (1) CD players for automotive use
- (2) CD car navigation systems

Outline Dimensions

(Unit : mm)



Absolute Maximum Ratings

(T_C=25°C)

Parameter	Symbol	Rating	Unit
① Optical power output	P _H	4.3	mW
Reverse voltage	V _R	2	V
		30	V
OPIC supply voltage	V _{CC}	6	V
② Operating temperature	T _{opr}	-20 to +80	°C
② Storage temperature	T _{stg}	-40 to +85	°C
③ Soldering temperature	T _{sold}	260	°C

① Output power from hologram laser, CW (Continuous Wave) drive

② Case temperature

③ At the position of 1.6mm from the lead base (Within 5s)

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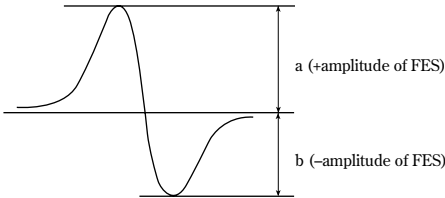
Electro-optical Characteristics

(Vcc=5V, Vs=1/2 Vcc, Tc=25°C)

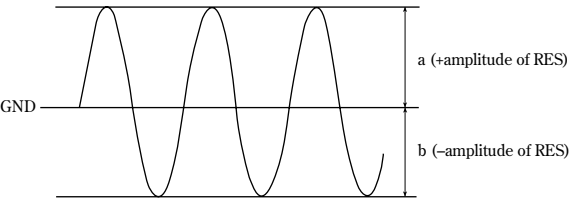
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
#1 Focal offset	DEF	V _{RF} =1.1V	-0.7	-	+0.7	μm
#2 Focal error symmetry	B _{FES}	V _{RF} =1.1V	-25	-	+25	%
#3 Radial error balance	B _{RES}	P _H =3.0mW	-25	-	+25	%
#4 RF output amplitude	V _{RF}	P _H =3.0mW	0.90	1.70	-	V
#5 FES output amplitude	V _{FES}	V _{RF} =1.1V	0.46	0.70	0.94	V
#6 RES output amplitude	V _{RES}	V _{RF} =1.1V	0.25	0.36	0.49	V
Threshold current	I _{th}	—	-	25	39	mA
Operating current	I _{op}	P _H =3.0mW	-	36	50	mA
Operating voltage	V _{op}	P _H =3.0mW	-	1.75	2.2	V
Wavelength	λ _p	P _H =3.0mW	770	780	795	nm
Output current	I _m	P _H =3.0mW, V _R =15V	(0.12)	0.55	1.00	mA
Differential efficiency	η _d	$\frac{2.0\text{mW}}{I(3.0\text{mW})-I(1.0\text{mW})}$	0.17	0.27	0.55	mW/mA

#1 Distance between FES=0 and jitter minimum point
At the condition of FES sensitivity = 20%/1μm

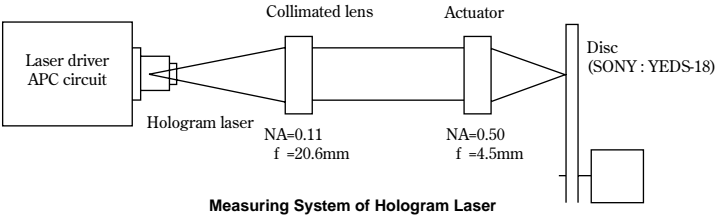
#2 (a-b) / (a+b)



#3 $\frac{a-b}{2 \times (a+b)}$ Offset of hologram laser is included.



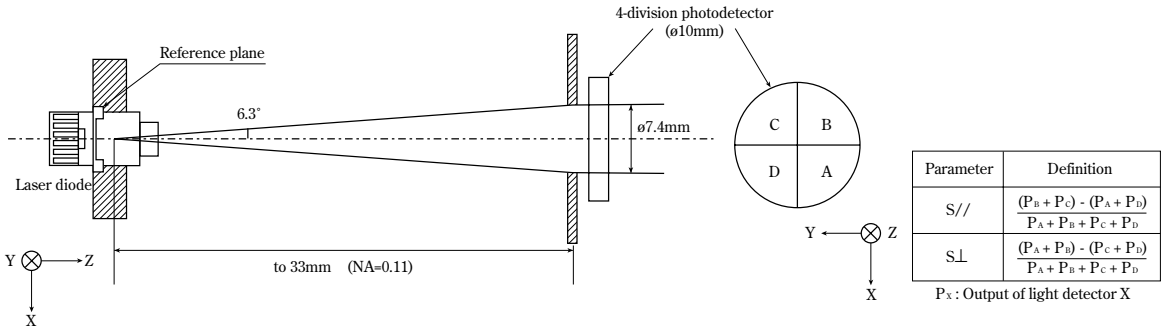
- #4 Amplitude of V_A+V_B+2V_C (focal servo ON, radial servo ON)
- #5 V_A-V_B (Focal vibration)
- #6 V_E-V_F (focal servo ON, radial servo OFF)



Electro-optical Characteristics of Laser Diode (Design Standard*) (Tc=25°C)

Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Emission characteristics	① Symmetry	Parallel	S//	Po=3mW, Into NA=0.11	-25	-	+25	%
		Perpendicular	S⊥		-15	-	+15	%
Misalignment position		Δx	—	-80	-	+80	μm	
		Δy		-80	-	+80	μm	
		Δz		-80	-	+80	μm	
Interference pattern intensity			α	Po=3mW	-	-	0.99	-

#1 Measuring method of radiation symmetry



Electrical Characteristics of Monitor Photodiode (Design Standard*) (Tc=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
#2 Sensitivity	S	VR=15V	-	0.20	-	mA/mW
Dark current	ID		-	-	150	nA
Terminal capacitance	Ct		-	3.5	-	pF

#2 For hologram output power

Electro-optical Characteristics of OPIC for Signal Detection (Design Standard*) (Tc=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	#3 Segment
Supply voltage	V _{CC}	-	2.8	3.0	5.5	V	-
Supply current	I _{CC}	V _{CC} =3V	1.8	4.2	6.7	mA	-
#4 Output offset voltage	V _{OD}	V _{CC} =3V No light	-11	0	+11	mV	V _A , V _B , V _C
			-13	0	+13	mV	V _E , V _F
Offset voltage difference	V _{OD}		-11	0	+11	mV	V _A -V _B
			-13	0	+13	mV	V _E -V _F
Response frequency	f _{CF}	#5 V _{CC} =3V, -3dB R _L =10kΩ, C _L =10pF	12	18	-	MHz	V _A , V _B , V _C
	f _{CR}		1.2	1.8	-	MHz	V _E , V _F

#3 Applicable divisions correspond to output terminals.

#4 Difference from Vcc/2

#5 Output amplitude=0dB (input signal 100kHz) BW=10kHz

		Segment No.	Output
D1	D4	D 1	V _E
D2		D 2	V _A
D3		D 3	V _B
D5		D 4	V _C
		D 5	V _F

* These parameters are not guaranteed performance, but general specifications of each optical element which makes up a hologram laser.
• Please refer to the chapter "Handling Precautions"

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